

Date: August 8, 2001

In re Application of: Shinji TAKEDA et al.1.

Serial No. 09/785,436

Filed: February 20, 2001

For: SEMICONDUCTOR DEVICE AND PROCESS FOR FABRICATION THEREOF

ASSISTANT COMMISSIONER FOR PATENTS

Box: FEE AMENDMENT

Washington, D. C. 20231

Sir:

Transmitted herewith is an Amendment in the above-identified application.

- [] Small entity status of this application under 37 CFR 1.9 and 1.27 has been established by a verified statement previously submitted.
- [] A verified statement to establish small entity status under 37 CFR 1.9 and 1.27 is hereby claimed.
- [] No additional fee is required.

The fee has been calculated as shown below:

(COL. 1)		(COL. 2)		(COL. 3)		SMALL ENTITY		OTHER THAN A SMALL ENTITY	
CLAIMS		HIGHEST NO.		PRESENT		RATE		RATE	
REMAINING		PREVIOUSLY		EXTRA		ADDIT. OR		ADDIT.	
AFTER		PAID FOR				FEE		FEE	
AMENDMENT									
TOTAL	* 53	MINUS	** 52	=	1	X 9 = \$	-0-	X 18 = \$	18.00
INDEP.	* 17	MINUS	*** 17	=	0	X 40 = \$		X 80 = \$	-0-
[] FIRST PRESENTATION OF MULTIPLE DEP. CLAIM						X135 = \$		X270 = \$	-0-

TOTAL
ADDIT. FEE \$ _____ OR TOTAL \$ 18.00

- * If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3.
- ** If the "Highest No. Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.
- *** If the "Highest No. Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space.
- The "Highest No. Previously Paid For" (Total or Independent) is the highest number found from the equivalent box in Col. 1 of a prior Amendment or the number of claims originally filed.

- [] Please charge my Deposit Account No. 501281 in the amount of \$ _____ duplicate copy of this sheet is attached.
- [XXX] A check (No. 1549) in the amount of \$ 18.00 is attached.
- [XXX] The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 501281. A duplicate copy of this sheet is attached.

- [XX] Any filing fees under 37 CFR 1.16 for the presentation of extra claims.
- [XX] Any patent application processing fees under 37 CFR 1.17.

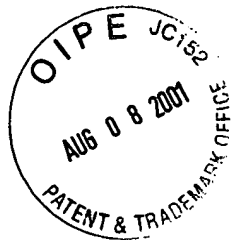
Joerg-Uwe Szipl
Reg. No. 31,799

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*Amdt
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A. Walker*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
Shinji TAKEDA et al.) Atty. Docket No.: **TM&K0007**
Serial No. 09/785,436)
Filed: February 20, 2001) Group Art Unit: 2813
For: SEMICONDUCTOR DEVICE AND)
PROCESS FOR FABRICATION) Examiner: S. GEYER
THEREOF) Date: August 8, 2001

AMENDMENT IN RESPONSE TO RESTRICTION REQUIREMENT

BOX: FEE RESPONSE

Assistant Commissioner for Patents
Washington, D. C. 20231

Sir:

In response to the Official Office Action dated July 23, 2001, kindly amend the application as follows:

IN THE CLAIMS:

Kindly add the following new claim:

B' C 48. (New) A process according to claim 39, wherein said filmy die-bonding material comprises a metal filler.

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